

STARPOWER

SEMICONDUCTOR™

IGBT

GD100HFU120C2S

Molding Type Module

1200V/100A 2 in one-package

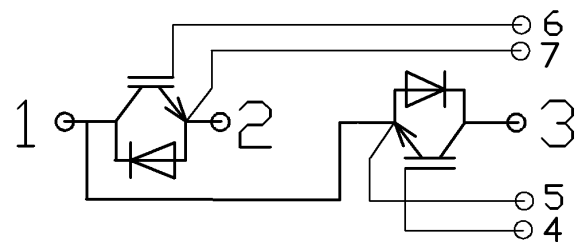
General Description

STARPOWER IGBT Power Module provides ultrafast Switching speed as well as short circuit ruggedness. It's designed for the applications such as electronic welders and Inductive heating.



Features

- High short circuit capability, self limiting to $6 \cdot I_{Cnom}$
- Rugged with ultrafast performance
- Low t_{rr} and I_{rr}
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- 10us short circuit capability
- Isolated copper baseplate using DCB Direct Copper Bonding technology



Typical Applications

- Switching mode power supplies at $f_{sw} > 20\text{kHz}$
- Resonant inverters up to 100kHz
- Inductive heating
- UPS
- Electronic welders at $f_{sw} > 20\text{kHz}$

Equivalent Circuit Schematic

Absolute Maximum Ratings $T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Description	GD100HFU120C2S	Units
V_{CES}	Collector-Emitter Voltage	1200	V

Symbol	Description	GD100HFU120C2S	Units
V_{GES}	Gate-Emitter Voltage	$\pm 20V$	V
I_C	Collector Current @80°C	100	A
$I_{CM(1)}$	Pulsed Collector Current @80°C	200	A
I_F	Diode Continuous Forward Current	100	A
I_{FM}	Diode Maximum Forward Current	200	A
P_D	Maximum power Dissipation @ Tc=25°C	800	W
T_J	Operating Junction Temperature	-40 to +150	°C
T_{STG}	Storage Temperature Range	-40 to +125	°C
I^2t -value, Diode	$V_R=0V, t=10ms, T_J=125^\circ C$	4000	A ² s
V_{ISO}	Isolation Voltage	2500	V
Mounting Torque	Power Terminal Screw:M6	2.5 to 5	N.m
	Mounting Screw:M6	3 to 5	N.m

Notes:

(1) Repetitive rating: Pulse width limited by max. junction temperature

Electrical Characteristics of IGBT $T_C=25^\circ C$ unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$B_{V_{CES}}$	Collector-Emitter Breakdown Voltage	$T_J=25^\circ C$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0V$		0.15	0.45	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V$ @ $T_J=25^\circ C$			200	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=4mA, V_{CE}=V_{GE}$	4.4	5.02	6.0	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=100A, V_{GE}=15V,$ @25°C		3.46	3.7	V
		$I_C=100A, V_{GE}=15V,$ @125°C		3.52		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=100A, R_G=9\Omega, V_{GE} = \pm 15V, \text{Inductive Load, } T_C = 25^\circ C$		100		ns
t_r	Rise Time			50		ns
$t_{d(off)}$	Turn-Off Delay Time			460		ns
t_f	Fall Time			21		ns
E_{on}	Turn-On Switching Loss			9		mJ

E_{off}	Turn-Off Switching Loss			5		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=100A, R_G=9\Omega, V_{GE} = \pm 15V$, Inductive Load, $T_C = 125^\circ C$		110		ns
t_r	Rise Time			62		ns
$t_{d(off)}$	Turn-Off Delay Time			500		ns
t_f	Fall Time			30		ns
E_{on}	Turn-On Switching Loss			9		mJ
E_{off}	Turn-Off Switching Loss			5		mJ
T_{SC}	Short Circuit Withstand Time	$V_{CC}=600V, V_{GE} = 20V@T_C = 125^\circ C$	10			us
C_{ies}	Input Capacitance	$V_{CE} = 20V, f=1MHz, V_{GE} = 0V$		13.6		nF
C_{oes}	Output Capacitance			1.11		nF
C_{res}	Reverse Transfer Capacitance			0.82		nF
L_{CE}	Stray inductance			20	25	nH
$R_{CC'+EE'}$	Module lead resistance, terminal to chip			0.8		m Ω

Electrical Characteristics of DIODE $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F =100A	T _C = 25°C		2.10	2.5	V
			T _C = 125°C		2.25		
t _{rr}	Diode Reverse Recovery Time	I _F =100A, V _R =600V,di /dt=-1000A/ us, V _{GE} =0V	T _C = 25°C		180		ns
			T _C = 125°C		---		
I _{rr}	Diode Peak Reverse Recovery Current		T _C = 25°C		50		A
			T _C = 125°C		75		
Q _{rec}	Reverse Recovery Charge		T _C = 25°C		6		uC
			T _C = 125°C		15		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)		0.15	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)		0.30	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.03		$^\circ C/W$
Weight	Weight of Module	300		g

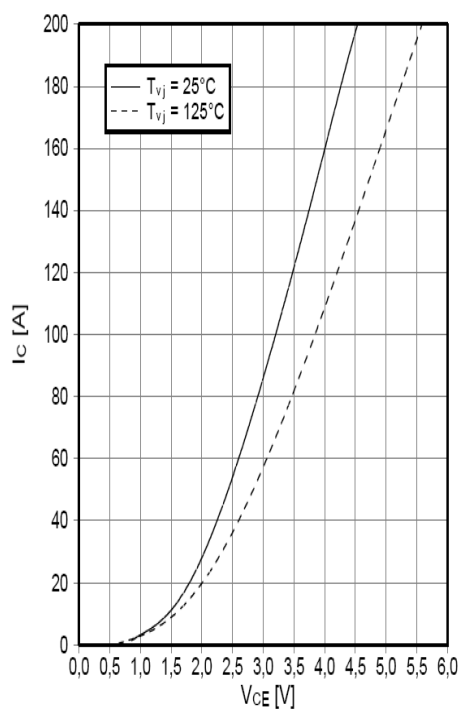


Fig 1. Typical Output Characteristics

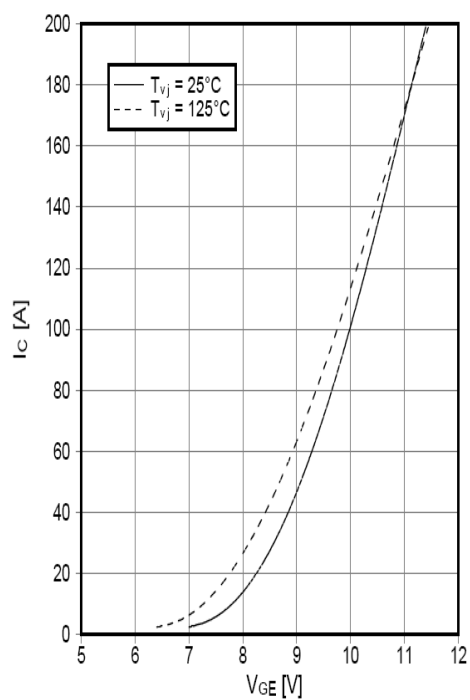


Fig 2. Typical transfer Characteristics

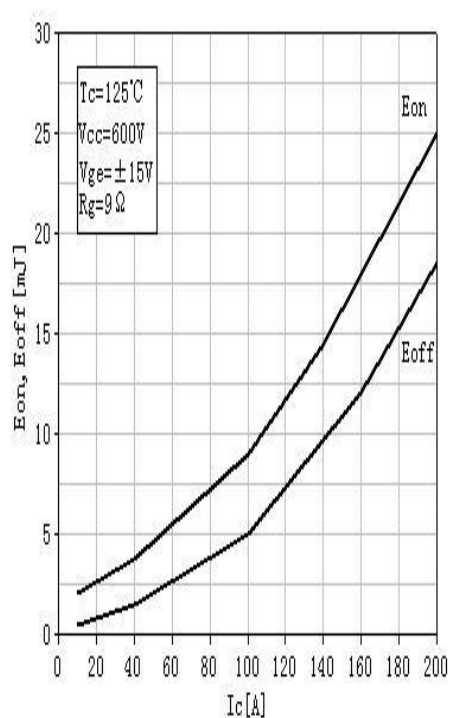


Fig 3. Switching Loss vs. Collector Current

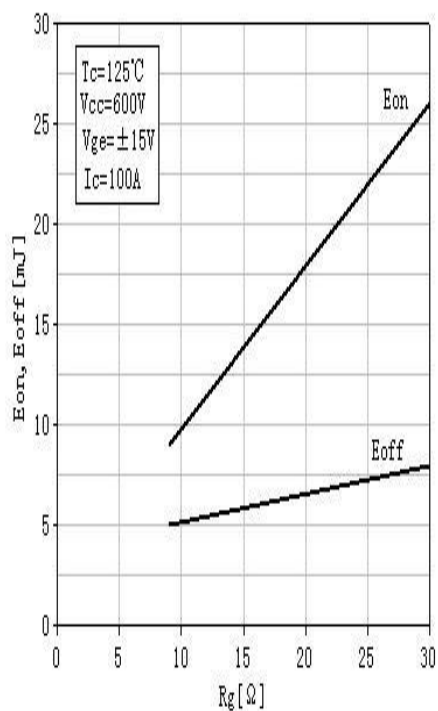


Fig 4. Switching Loss vs. Gate Resistance

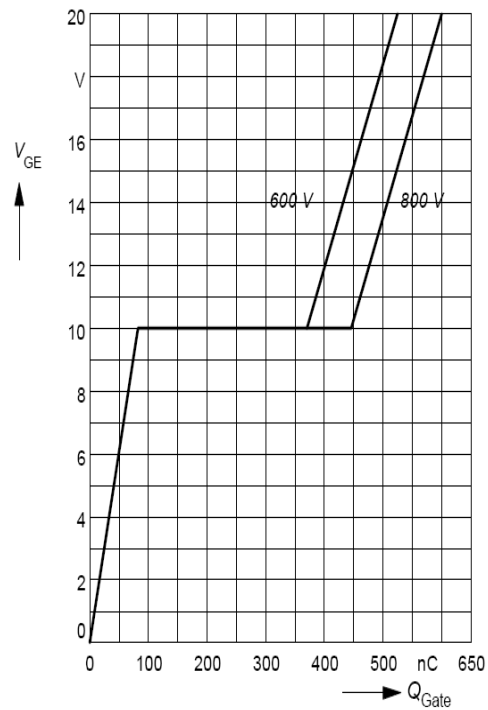
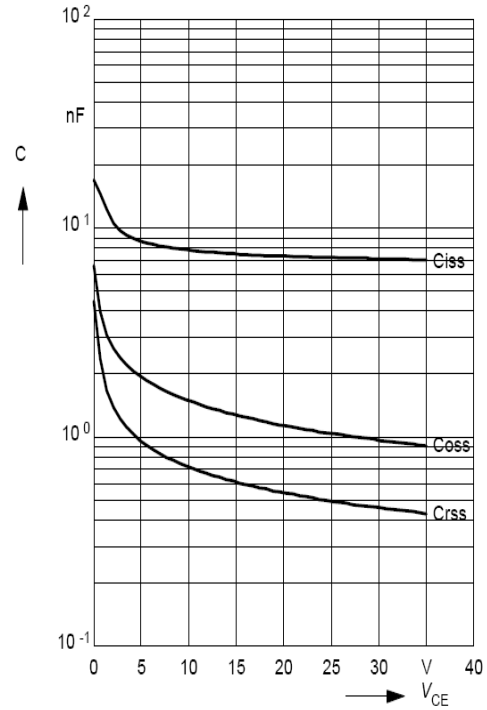
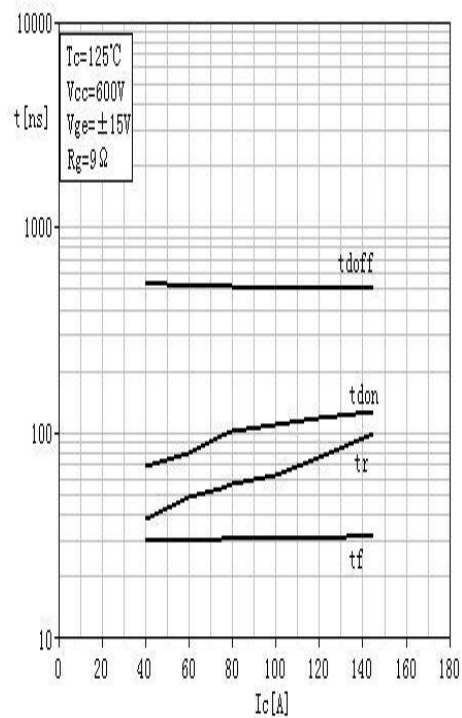
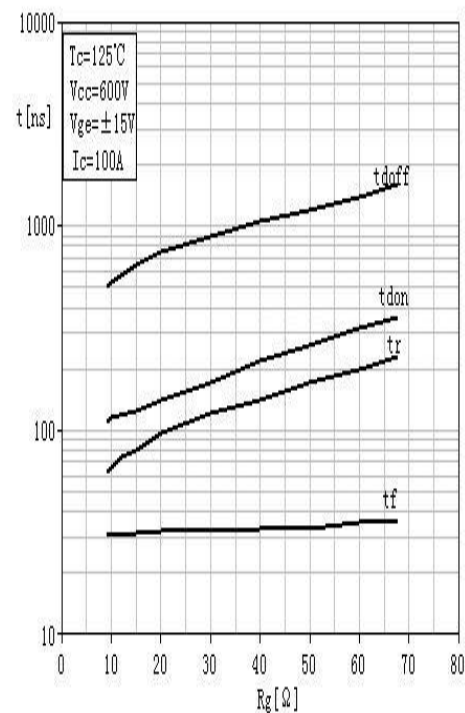
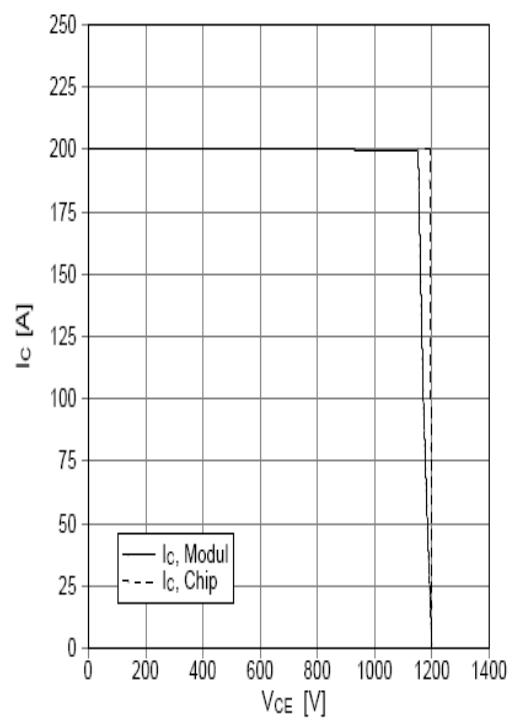
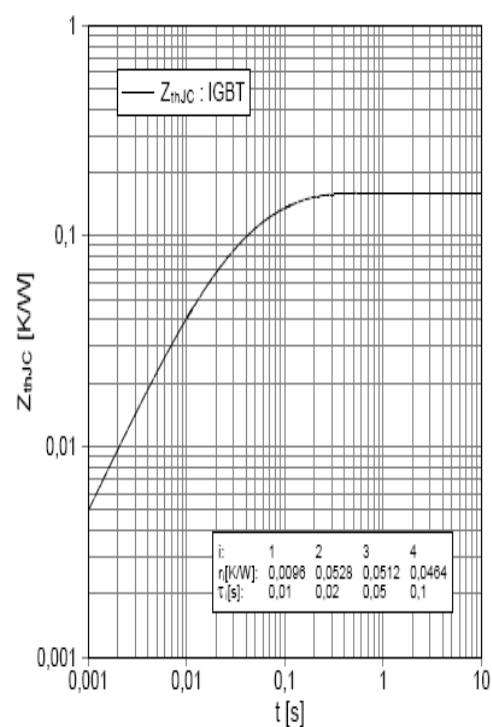
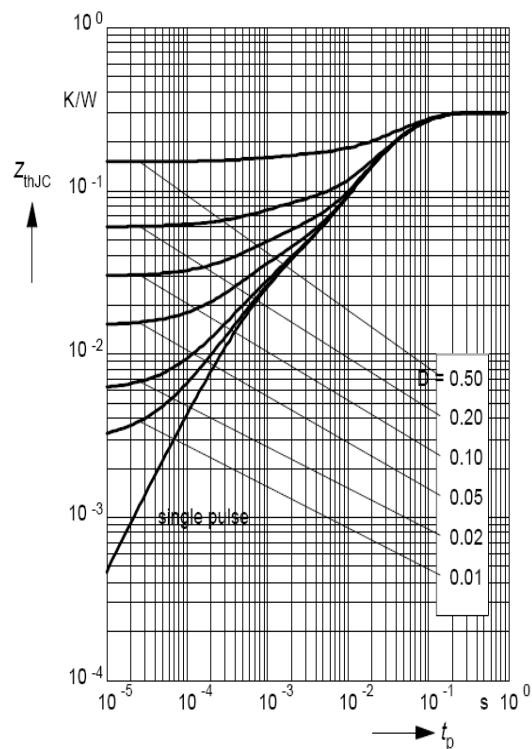
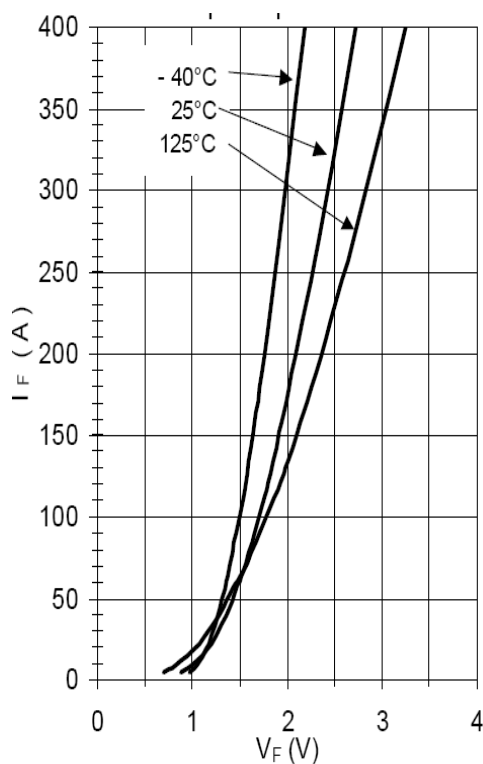


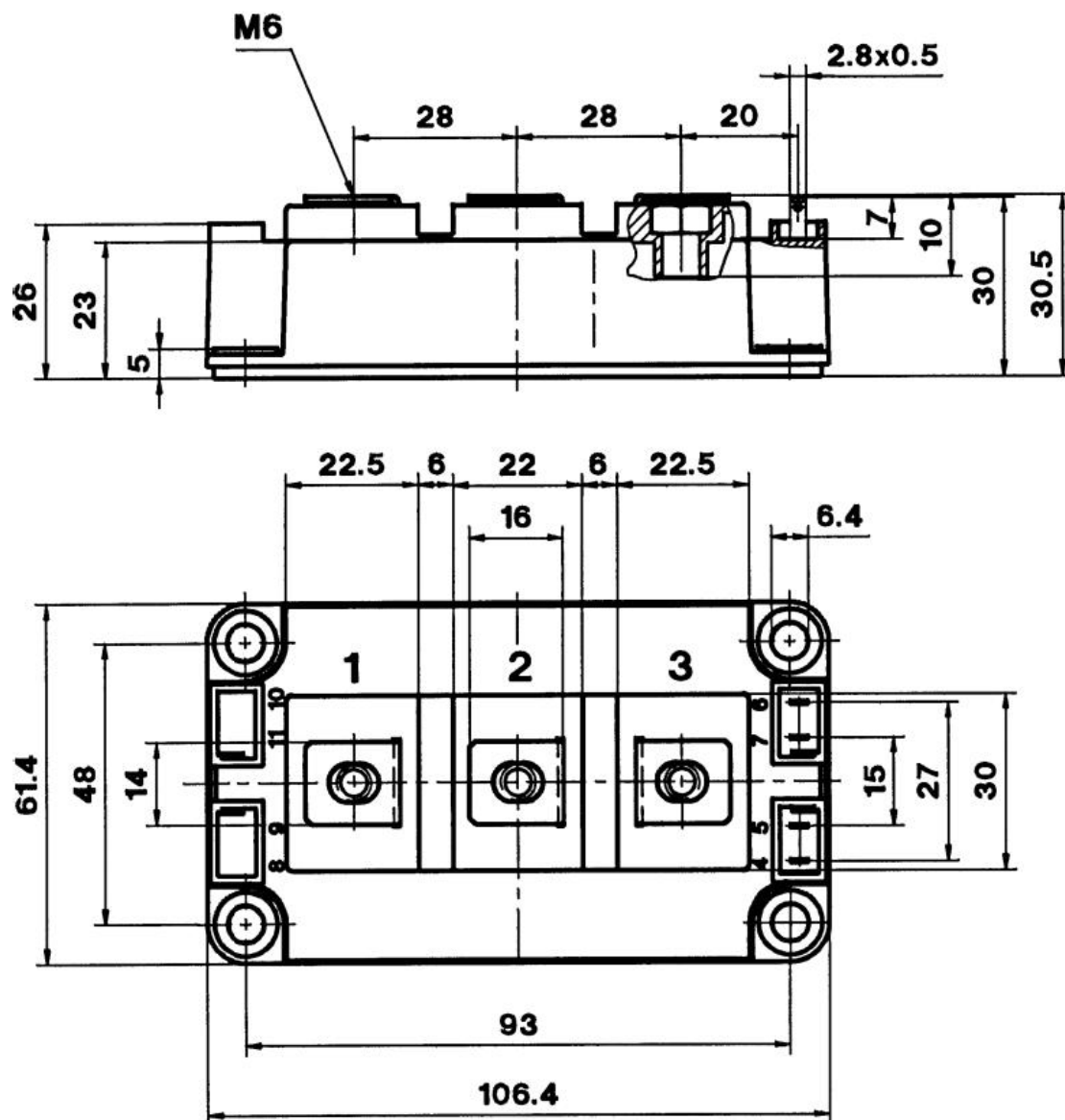
Fig 5. Gate Charge Characteristics.

Fig 6. Typical Capacitance vs.
Collector-Emitter CurrentFig 7. Typical Switching Times vs. I_C Fig 8. Typical Switching Times vs. Gate
Resistance R_G



Package Dimension

Dimensions in Millimeters



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